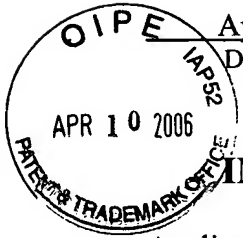


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April 6, 2006

Date Mailed

Yuko Tanaka

Name

U. Tanaka

Signature

April 6, 2006

Date

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Koning *et al.*

Serial No.: 10/815,291

Filed: March 30, 2004

For: MICROELECTRONIC PACKAGES
INCLUDING NANOCOMPOSITE
DIELECTRIC BUILD-UP MATERIALS
AND NANOCOMPOSITE SOLDER
RESIST

Examiner: Luan C. Thai

Art Unit: 2891

Docket No.: 42P18770

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT A (37 C.F.R. § 1.111)

Sir:

This amendment is submitted in response to the Office Action mailed December 8, 2005, for the above-noted patent application.

Applicants respectfully request that the Examiner do the following with this amendment:

1. Please enter the amendments to the specification, if any, in section I.
2. Please enter the amendments to the claims, if any, in section II.
3. Please consider the specification amendments in section I and the claims in section II in view of the remarks in section III.